Vishay Sfernice

Precision Surface Mount Resistors Wirewound Technology

FEATURES

- According to EN 140402-801 (wirewound)
- Wide range of ohmic values (0.04 Ω to 13 kΩ)
- Low temperature coefficient (± 25 ppm/°C available)
- · Good electrical insulation
- · All welded construction and molded encapsulant
- High power ratings (up to 2.5 W)
- Stability class 0.5
- · Pure matte tin termination
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Specially designed for surface mounting, the MSP series uses wirewound technology. The molded package ensures mechanical and climatic protection as well as high dielectric insulation. The MSP design is compatible with surface mounting equipment and can withstand wave and reflow soldering techniques.

DIMENSIONS in millimeters									
				Recommended Soldering Areas					
SERIES	Α	В	с	D	F	w	x	z	WEIGHT in g
MSP 1	6.8	3.9	3.8	2.5	1.4	2.7	2.9	6	0.2
MSP 2	11.4	5	7	5	2.2	5.2	4.1	9.4	0.8
MSP 3	14.6	6.6	7	5	2.3	5.2	4.1	12.7	1.5

Note

General tolerance: ± 0.2 mm

STANDARD ELECTRICAL SPECIFICATIONS								
MODEL	RESISTANCE RANGE Ω	RATED POWER P _{25 °C} W	LIMITING ELEMENT VOLTAGE V	TOLERANCE ± %	TEMPERATURE COEFFICIENT ± ppm/°C			
MSP 1 B	0.04 to 2.2K	1	50	0.5, 1, 2, 5	25, 50, 100			
MSP 2 B	0.04 to 4.7K	2	120	0.5, 1, 2, 5	25, 50, 100			
MSP 3 B	0.04 to 13K	2.5	200	0.5, 1, 2, 5	25, 50, 100			

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RoHS COMPLIANT

MSP



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MSP

TECHNICAL SPECIFICATIONS							
RESISTIVE TECHNOL	DGY	Wirewound					
Vishay Sfernice Series		MSP 1 B	MSP 2 B	MSP 3 B			
Metric Size		0704M	1107M	1607M			
Rated Dissipation at +2	5 °C, P ₂₅	1 W	2 W	2.5 W			
	± 5 % E24 Series	0.04 to 2.2K	0.04 to 4.7K	0.04 to 13K			
Ohmic Range in Relation to Tolerance	± 2 % E48 Series	0.1 to 2.2K	0.04 to 4.7K	0.05 to 13K			
(with Preferred Ohmic Value Series)	± 1 % E96 Series	0.1 to 2.2K	0.04 to 4.7K	0.05 to 13K			
	± 0.5 % E96 Series	1.4 to 2.2K	0.4 to 4.7K	0.3 to 13K			
Limiting Element Voltage, Umax. AC/DC		50 V	120 V	200 V			
Series		MSP 1 B	MSP 2 B	MSP 3 B			
Critical Resistance				-			
Temperature Coefficien	t		CECC 40402-801 -55 °C / +200 °C $< 1 \Omega \pm 100 \text{ ppm/°C}$ $1 \Omega \text{ to } < 10 \Omega \pm 50 \text{ ppm/°C}$ $\ge 10 \Omega \pm 25 \text{ ppm/°C}$				
Failure Rate		E6 E6 E0 or / 10 ⁻⁶ /h 10 ⁻⁶ /h 10 ⁻⁴ /h					

MECHANICAL SPECIFICATIONS					
RESISTIVE TECHNOLOGY	Wirewound				
Encapsulant	Thermoset				
Resistive Element	CuNi or NiCr				
Ceramic Substrate	Alumina or Steatite				
Termination	Electrolytic pure matte tin				

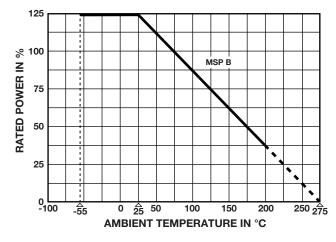
ENVIRONMENTAL SPECIFICATIONS					
RESISTIVE TECHNOLOGY	Wirewound				
Temperature Range	-55 °C to 275 °C				
Climatic Category (LCT/UCT/days)	55/200/56				



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PERFORMANCE						
	CONDITIONS	REQUIREMENTS				
TESTS	Wirewound	Wirewound EN 140402-801				
Short Time Overload	IEC 60115-1 5 <i>P</i> _r or <i>U</i> = 2 <i>U</i> _{max.} /5 s	± (0.25 % + 0.05 Ω)				
Load Life	IEC 60115-1 90'/30' cycles 1000 h <i>P</i> _r + 25 °C 8000 h <i>P</i> _r	\pm (0.5 % + 0.05 Ω) \pm (3 % + 0.05 Ω)				
Dielectric w/s Voltage	IEC 60115-1 <i>U</i> _{RMS} = 500 V/60 s	No flashover or breakdown Leakage current < 10 μA				
Rapid Change of Temperature	IEC 60115-1 IEC 60068-2-14 Test Na 5 cycles (30' at LCT/30' at UCT) -55 °C / +200 °C	± (0.25 % + 0.05 Ω)				
Climatic Sequence	IEC 60115-1 -55 °C / +200 °C	± (0.5 % + 0.05 Ω)				
Humidity (Steady State)	IEC 60115-1 IEC 60068-2-3 Test Ca 95 % HR/40 ℃ 56 days	± (0.5 % + 0.05 Ω)				
Substrate Bending Test	IEC 60115-1 IEC 60068-2-21 Test U _{e3} 2 mm/10 times	± (0.25 % + 0.05 Ω)				
Shock	IEC 60115-1 IEC 60068-2-27 Test Ea 50 g's/half sine/3 times by direction (i.e. 18 shocks)	± (0.25 % + 0.05 Ω)				
Vibration	IEC 60115-1 IEC 60068-2-6 Test Fc 10 Hz/2000 Hz	± (0.25 % + 0.05 Ω)				
Resistance to Soldering Heat	IEC 60115-1 IEC 60068-2-58 Solder Bath 260 °C/10 s	± (0.5 % + 0.05 Ω)				

POWER RATING

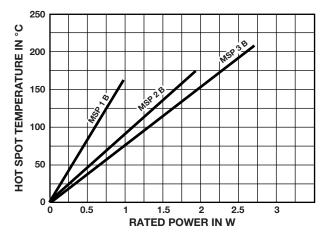


SURFACE MOUNTING OF MSP B

Soldering cycle: 2 min at 215 °C or 10 s at 260 °C or with an iron 40 W: 3 s at 350 °C.

Soldering is possible by wave, reflow and vapor phase.

TEMPERATURE RISE



NON INDUCTIVE WINDING FOR MSP B

Non-inductive (Ayrton Perry) winding available. Please consult Vishay Sfernice.

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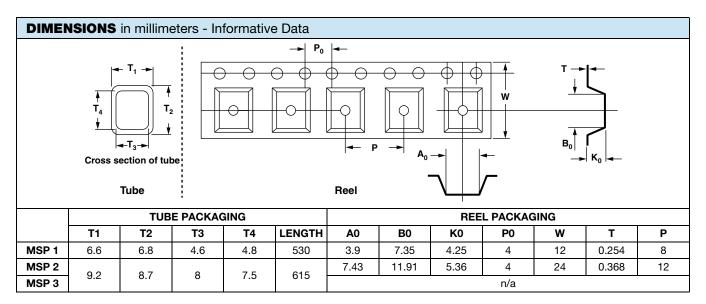
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PACKAGING

In bulk (plastic bag of 100 units or multiples)

- In tube: MSP1 70 units per tube
 - MSP2 50 units per tube
 - MSP3 40 units per tube

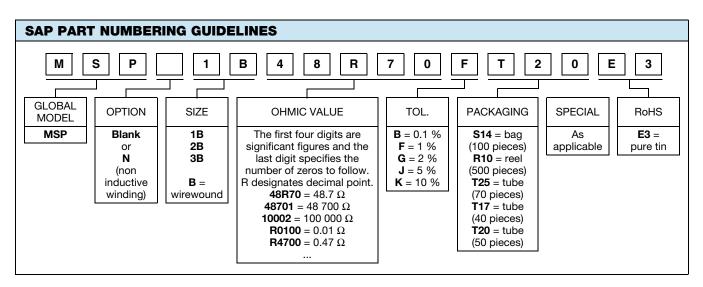
In reel of 500 units for MSP1 and MSP2



MARKING

Vishay Sfernice trademark, ohmic value (in Ω), tolerance (in %), series and style, technology, manufacturing date.

ORDERING INFORMATION								
MSP	1	В		48U7	±1%	тс	BA100	e3
SERIES	STYLE	TECHNOLOGY	NON INDUCTIVE WINDING	OHMIC VALUE	TOLERANCE	only in "C"	PACKAGING	LEAD (Pb)-FREE
		B: wirewound	Optional			technology		



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